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LNBH25

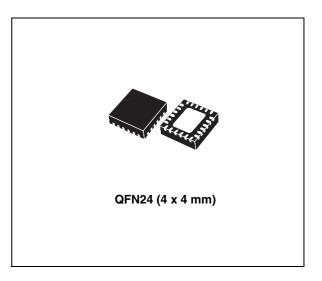
LNB supply and control IC with step-up and I²C interface

Features

- Complete interface between LNB and I²C bus
- Built-in DC-DC converter for single 12 V supply operation and high efficiency (typ. 93 % @ 0.5 A)
- Selectable output current limit by external resistor
- Compliant with main satellite receivers output voltage specification (15 programmable levels)
- Accurate built-in 22 kHz tone generator suits widely accepted standards
- 22 kHz tone waveform integrity guaranteed also at no load condition
- Low-drop post regulator and high efficiency step-up PWM with integrated power N-MOS allowing low power losses
- LPM function (low power mode) to reduce dissipation
- Overload and overtemperature internal protections with I²C diagnostic bits
- LNB short-circuit dynamic protection
- +/- 4 kV ESD tolerant on output power pins

Applications

- STB satellite receivers
- TV satellite receivers
- PC card satellite receivers



Description

Intended for analog and digital satellite receivers/Sat-TV and Sat-PC cards, the LNBH25 is a monolithic voltage regulator and interface IC, assembled in QFN24 4x4 specifically designed to provide the 13/18 V power supply and the 22 kHz tone signalling to the LNB down-converter in the antenna dish or to the multi-switch box. In this application field, it offers a complete solution with extremely low component count and low power dissipation together with a simple design and I²C standard interfacing.

Table 1. Device summary

Order code	Package	Packaging
LNBH25PQR	QFN24 (4 x 4)	Tape and reel

Contents

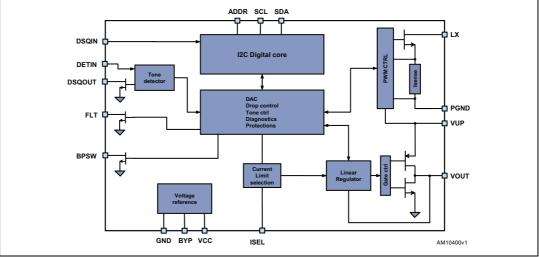
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1 Block diagram







2 Application information

This IC has a built-in DC-DC step-up converter that, from a single source (8 V to 16 V), generates the voltages (V_{up}) that let the integrated LDO post-regulator (generating the 13 V /18 V LNB output voltages plus the 22 kHz DiSEqCTM tone) to work with a minimum dissipated power of 0.5 W typ. @ 500 mA load (the LDO drop voltage is internally kept at V_{up} - V_{OUT} = 1 V typ.). The LDO power dissipation can be further reduced when the 22 kHz tone output is disabled by setting the LPM bit to "1" (see *2.4: LPM (low power mode)*). The IC is also provided with an undervoltage lockout circuit that disables the whole circuit when the supplied V_{CC} drops below a fixed threshold (4.7 V typ.). The step-up converter soft-start function reduces the inrush current during start-up. The SS time is internally fixed at 4 ms typ. to switch from 0 to 13 V and 6 ms typ. switch from 0 to 18 V.

2.1 DiSEqC data encoding (DSQIN pin)

The internal 22 kHz tone generator is factory trimmed in accordance to DiSEqC standards, and can be activated in 3 different ways:

- 1. by an external 22 kHz source DiSEqC data connected to the DSQIN logic pin (TTL compatible). In this case the I²C Tone control bits must be set: EXTM = TEN = 1.
- by an external DiSEqC data envelope source connected to the DSQIN logic pin. In this case the I²C Tone control bits must be set: EXTM = 0 and TEN = 1.
- 3. through the TEN I²C bit if a 22 kHz presence is requested in continuous mode. In this case the DSQIN TTL pin must be pulled HIGH and EXTM bit set to "0".

Each of the above solutions requires that during the 22 kHz tone activation and/or DiSEqC data transmission, the LPM bit must be set to "0" (see *2.4: LPM (low power mode)*).

2.2 Data encoding by external 22 kHz tone TTL signal

In order to improve design flexibility an external tone signal can be input to the DSQIN pin by setting the EXTM bit to "1".

The DSQIN is a logic input pin which activates the 22 kHz tone to the $V_{\rm OUT}$ pin, by using the LNBH25 integrated tone generator.

The output tone waveforms are internally controlled by the LNBH25 tone generator in terms of rise/fall time and tone amplitude, while, the external 22 kHz signal on the DSQIN pin is used to define the frequency and the duty cycle of the output tone. A TTL compatible 22 kHz signal is required for the proper control of the DSQIN pin function. Before sending the TTL signal on the DSQIN pin, the EXTM and TEN bits must be previously set to "1". As soon as the DSQIN internal circuit detects the 22 kHz TTL external signal code, the LNBH25 activates the 22 kHz tone on the V_{OUT} output with about 1 μ s delay from TTL signal activation, and it stops with about 60 μ s delay after the 22 kHz TTL signal on DSQIN has expired (refer to *Figure 2*).



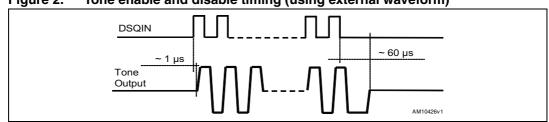


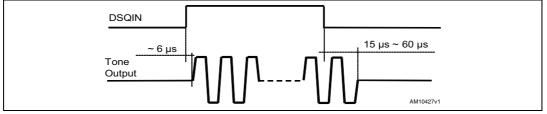
Figure 2. Tone enable and disable timing (using external waveform)

2.3 Data encoding by external DiSEqC envelope control through the DSQIN pin

If an external DiSEqC envelope source is available, it is possible to use the internal 22 kHz generator activated during the tone transmission by connecting the DiSEqC envelope source to the DSQIN pin. In this case the I²C Tone control bits must be set: EXTM = 0 and TEN = 1. In this way, the internal 22 kHz signal is superimposed to the V_{OUT} DC voltage to generate the LNB output 22 kHz tone. During the period in which the DSQIN is kept HIGH, the internal control circuit activates the 22 kHz tone output.

The 22 kHz tone on the V_{OUT} pin is activated with about 6 μ s delay from the DSQIN TTL signal rising edge, and it stops with a delay time in the range from 15 μ s to 60 μ s after the 22 kHz TTL signal on DSQIN has expired (refer to *Figure 3*).





2.4 LPM (low power mode)

In order to reduce total power loss, the LNBH25 is provided with the LPM I²C bit that can be activated (LPM=1) in applications where the 22 kHz tone can be disabled for long time periods. The LPM bit can be set to "1" when the DiSEqC data transmission is not requested (no 22 kHz tone output is present); at this condition the drop voltage across the integrated LDO regulator (V_{UP} - V_{OUT}) is reduced to 0.6 V typ. and, consequently, the power loss inside the LNBH25 linear regulator is reduced too. For example: at 500 mA load, LPM=1 allowing a minimum LDO dissipated power of 0.3 W typ. It is recommended to set the LPM bit to "0" before starting the 22 kHz DiSEqC data transmission; at this condition the drop voltage across the LDO is kept to 1 V typ. Keep LPM=0 at all times in case the LPM function is not used.

2.5 DiSEqC 2.0 implementation

The built-in 22 kHz tone detector completes the fully bi-directional DiSEqC 2.0 interfacing. The input pin (DETIN) must be AC coupled to the DiSEqC BUS, and extracted PWK data is available on the DSQOUT pin. To comply with the bi-directional DiSEqC 2.0 bus hardware



requirements an output RL filter is needed. In order to avoid 22 kHz waveform distortion during tone transmission, LNBH25 is provided with the BPSW pin to be connected to an external transistor, which allows to bypass the output RL filter in DiSEqC 2.x applications while in transmission mode. Before starting tone transmission by means of the DSQIN pin, make sure that the TEN bit is preventively set to "1" and after ending tone transmission, make sure that the TEN bit is set to "0".

2.6 Output current limit selection

The linear regulator current limit threshold can be set by an external resistor connected to the ISEL pin. The resistor value defines the output current limit by the equation:

Equation 1

 I_{MAX} (typ.) = $\frac{13915}{RSEL^{1.111}}$

with ISET=0

Equation 2

$$I_{MAX}(typ.) = \frac{6808}{RSEL^{1.068}}$$

with ISET=1

(Refer also to the ISET bit description in Table 9).

where RSEL is the resistor connected between ISEL and GND expressed in $k\Omega$ and $I_{MAX}(typ.)$ is the typical current limit threshold expressed in mA. I_{MAX} can be set up to 1 A.

2.7 Output voltage selection

The linear regulator output voltage level can be easily programmed in order to accomplish application specific requirements, using 4 bits of an internal DATA 1 register (see *7.3: Data registers* and *Table 14* for exact programmable values). Register writing is accessible via the I²C bus.

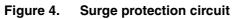
2.8 Diagnostic and protection functions

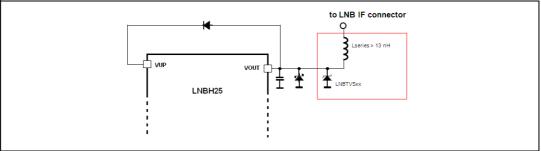
LNBH25 has 8 diagnostic internal functions provided via the I²C bus, by reading 8 bits on two STATUS registers (in read mode). All the diagnostic bits are, in normal operation (that is no failure detected), set to LOW. Two diagnostic bits are dedicated to the overtemperature and overload protection status (OTF and OLF) while the remaining 6 bits are dedicated to the output voltage level (VMON), to 22 kHz tone characteristics (TMON), to the minimum load current (IMON), to external voltage source presence on the V_{OUT} pin (PDO), to the input voltage Power Not Good function (PNG) and to the 22 kHz tone presence on the DETIN pin (TDET). Once the OLF (or OTF or PNG) bit has been activated (set to "1"), it is latched to "1" until relevant cause is removed and a new register reading operation is done.



2.9 Surge protections and TVS diodes

The LNBH25 device is directly connected to the antenna cable in a set-top box. Atmospheric phenomenon can cause high voltage discharges on the antenna cable causing damage to the attached devices. Surge pulses occur due to direct or indirect lightning strikes to an external (outdoor) circuit. This leads to currents or electromagnetic fields causing high voltage or current transients. Transient voltage suppressor (TVS) devices are usually placed, as shown in the following schematic, to protect the STB output circuits where the LNBH25 and other devices are electrically connected to the antenna cable.





For this purpose we recommend the use of LNBTVSxx surge protection diodes specifically designed by ST. The selection of LNBTVS diodes should be made based on the maximum peak power dissipation that the diode is capable of supporting (see Ppp (W) parameter in the LNBTVS datasheet for further details).

2.10 FLT: fault flag

In order to get an immediate feedback on diagnostic status, LNBH25 is equipped with a dedicated fault flag pin (FLT). In the case of overload (OLF bit=1) or overheating (OTF bit=1) or if Power No Good (PNG bit=1) condition is detected, the FLT pin (open drain output) is set to low and is kept low until the relevant activating diagnostic bit is cleared. Be aware that diagnostic bits OLF, OTF and PNG, once activated, are kept latched to "1" until the cause origin is removed and a new register reading operation is performed by the microprocessor. The FLT pin must be connected to a positive voltage (5 V max.) by means of a pull-up resistor.

2.11 VMON: output voltage diagnostic

When device output voltage is activated (V_{OUT} pin), its value is internally monitored and, as long as the output voltage level is below the guaranteed limits, the VMON I²C bit is set to "1". See *Table 17* for more details.

2.12 TMON: 22 kHz tone diagnostic

The 22 kHz tone can be internally detected and monitored if the DETIN pin is connected to the LNB output bus (see typical application circuit in *Figure 7*) through a decoupling capacitor.

The tone diagnostic function is provided with the TMON I²C bit. If the 22 kHz tone amplitude and/or the tone frequency is out of the guaranteed limits (see *Table 19*), the TMON I²C bit is set to "1".



2.13 TDET: 22 kHz tone detection

When a 22 kHz tone presence is detected on the DETIN pin, the TDET I²C bit is set to "1".

2.14 IMON: minimum output current diagnostic

In order to detect the output load absence (no LNB connected on the bus or cable not connected to the IRD) the LNBH25 is provided with a minimum output current flag by the IMON I²C bit, accessible in read mode, which is set to "1" if the output current is lower than 12 mA (typ.). It is recommended to use IMON function only with the 22 kHz tone transmission deactivated, otherwise the IMON bit could be set to "0" even if the output current is below the minimum current threshold. To activate IMON diagnostic function, set to "1" the EN_IMON I²C bit in the DATA 4 register. Be aware that as soon as the IMON function is activated by means of EN_IMON=1, the V_{OUT} is immediately increased to 21 V (typ.) independently on the VSEL bit setting. This operation is applied in order to be sure that the LNBH25 output has the higher voltage present in the LNB bus. Do not use this function in an application environment where 21 V voltage level is not supported by other peripherals connected to the LNB bus.

2.15 PDO: overcurrent detection on output pull-down stage

When an overcurrent occurs on the pull-down output stage due to an external voltage source greater than LNBH25 nominal V_{OUT} and for a time longer than I_{SINK_TIME-OUT} (10 ms typ.), the PDO I²C bit is set to "1". This may happen due to an external voltage source present on the LNB output (V_{OUT} pin).

For current threshold and deglitch time details, see Table 13.

2.16 Power-on I²C interface reset and undervoltage lockout

The I²C interface built into LNBH25 is automatically reset at power-on. As long as the V_{CC} stays below the undervoltage lockout (UVLO) threshold (4.7 V typ.), the interface does not respond to any I²C command and all DATA register bits are initialized to zeroes, therefore keeping the power blocks disabled. Once the V_{CC} rises above 4.8 V typ. the I²C interface becomes operative and the DATA registers can be configured by the main microprocessor.

2.17 PNG: input voltage minimum detection

When input voltage (V_{CC} pin) is lower than LPD (low power diagnostic) minimum thresholds, the PNG I²C bit is set to "1" and the FLT pin is set low. Refer to *Table 13* for threshold details.

2.18 ISW: inductor switching current limit

In order to allow low saturation current inductors to be used, the maximum DC-DC inductor switching current limit threshold can be set by means of one I^2C bit (ISW). Two values are available: 2.5 A typ. (with ISW = 1) and 4 A typ. (with ISW = 0).



2.19 COMP: boost capacitor ESR

DC-DC converter compensation loop can be optimized in order to work well with high or low ESR capacitors (on the V_{UP} pin). For this purpose, one I²C bit in the DATA 4 register (COMP) can be set to "1" or "0". It is recommended to reset this bit to "0" unless using high ESR capacitors.

2.20 OLF: overcurrent and short-circuit protection and diagnostic

In order to reduce the total power dissipation during an overload or a short-circuit condition, the device is provided with a dynamic short-circuit protection. It is possible to set the shortcircuit current protection either statically (simple current clamp) or dynamically by the PCL bit of the I²C DATA 3 register. When the PCL (pulsed current limiting) bit is set Io LOW, the overcurrent protection circuit works dynamically: as soon as an overload is detected, the output current is provided for T_{ON} time (90 ms or 180 ms typ., according to the TIMER bit programmed in the DATA 3 register) and after that, the output is set in shutdown for T_{OFF} time of typically 900 ms. Simultaneously, the diagnostic OLF I²C bit of the system register is set to "1" and the FLT pin is set to low level. After this time has elapsed, the output is resumed for a time T_{ON}. At the end of T_{ON}, if the overload is still detected, the protection circuit cycles again through T_{OFF} and T_{ON}. At the end of a full T_{ON} in which no overload is detected, normal operation is resumed and the OLF diagnostic bit is reset to LOW after a register reading is done. Typical T_{ON} +T_{OFF} time is 990 ms (if TIMER=0) or 1080 ms (if TIMER=1) and an internal timer determines it. This dynamic operation can greatly reduce the power dissipation in short-circuit condition, still ensuring excellent power-on startup in most conditions. However, there could be some cases in which a highly capacitive load on the output may cause a difficult startup when the dynamic protection is chosen. This can be solved by initiating any power startup in static mode (PCL=1) and, then, switching to the dynamic mode (PCL=0) after a chosen amount of time depending on the output capacitance. Also in static mode, the diagnostic OLF bit goes to "1" (and the FLT pin is set to low) when the current clamp limit is reached and returns LOW when the overload condition is cleared and register reading is done.

After the overload condition is removed, normal operation can be resumed in two ways, according to the OLR I²C bit on the DATA 4 register.

If OLR=1, all VSEL 1..4 bits are reset to "0" and LNB output (V_{OUT} pin) is disabled. To reenable output stage, the VSEL bits must be set again by the microprocessor, and the OLF bit is reset to "0" after a register reading operation.

If OLR=0, output is automatically re-enabled as soon as the overload condition is removed, and the OLF bit is reset to "0" after a register reading operation.

2.21 OTF: thermal protection and diagnostic

The LNBH25 is also protected against overheating: when the junction temperature exceeds 150 °C (typ.), the step-up converter and the linear regulator are shut off, the diagnostic OTF bit in the STATUS1 register is set to "1" and the FLT pin is set to low level. After the overtemperature condition is removed, normal operation can be resumed in two ways, according to the THERM I²C bit on the DATA 4 register.

If THERM=1, all VSEL 1..4 bits are reset to "0" and LNB output (V_{OUT} pin) is disabled. To reenable output stage, the VSEL bits must be set again by the microprocessor, while the OTF bit is reset to "0" after a register reading operation.

If THERM=0, output is automatically re-enabled as soon as the overtemperature condition is removed, while the OTF bit is reset to "0" after a register reading operation.



3 Pin configuration

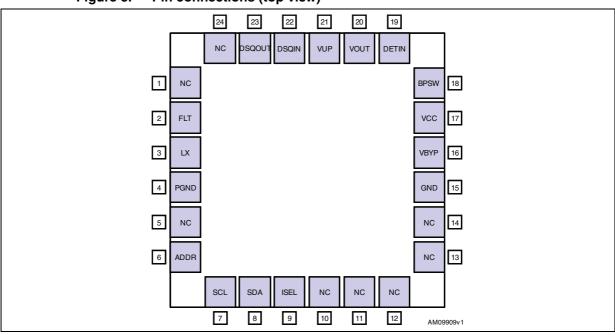


Figure 5. Pin connections (top view)

Pin n°	n° Symbol Name Pin function		
Pin h	Symbol	Name	Piniuncuon
2	FLT	FLT	Open drain output for IC fault conditions. It is set low in case of overload (OLF bit) or overheating status (OTF bit) or power not good (PNG) is detected. To be connected to pull-up resistor (5 V max.).
3	LX	N-MOS drain	Integrated N-channel Power MOSFET drain.
4	P-GND	Power ground	DC-DC converter power ground. To be connected directly to the Epad.
6	ADDR	Address setting	Two I ² C bus addresses available by setting the address pin level voltage. See <i>Table 16</i> .
7	SCL	Serial clock	Clock from I ² C BUS.
8	SDA	Serial data	Bi-directional data from/to I ² C BUS.
9	ISEL	Current selection	The resistor "RSEL" connected between ISEL and GND defines the linear regulator current limit threshold. Refer to <i>Section 2.6</i> in the Application Information section. Also see the ISET bit description in <i>Table 9</i> .
15	GND	Analog ground	Analog circuits ground. To be connected directly to the Epad.
16	ВҮР	Bypass capacitor	Needed for internal pre-regulator filtering. The BYP pin is intended only to connect an external ceramic capacitor. Any connection of this pin to external current or voltage sources may cause permanent damage to the device.
17	V _{CC}	Supply input	8 to 16 V IC DC-DC power supply.



Pin n°	Symbol	Name	Pin function
18	BPSW	Switch control	To be connected to an external transistor to be used to bypass the output RL filter needed in DiSEqC 2.x applications during the DiSEqC transmitting mode (see <i>Section 5</i>). Set to ground if not used. Open drain pin.
19	DETIN	Tone detector input	22 kHz tone decoder input open drain pin, must be AC coupled to the DiSEqC 2.0 bus. Set to ground if not used.
20	V _{OUT}	LNB output port	Output of the integrated very low drop linear regulator. See <i>Table 14</i> for voltage selections and description.
21	V _{UP}	Step-up voltage	Input of the linear post-regulator. The voltage on this pin is monitored by the internal step-up controller to keep a minimum dropout across the linear pass transistor.
22	DSQIN	DSQIN for DiSEqC envelope input or External 22 kHz TTL input	It can be used as DiSEqC envelope input or external 22 kHz TTL input depending on the EXTM I ² C bit setting as follows: EXTM=0, TEN=1: it accepts the DiSEqC envelope code from the main microcontroller. The LNBH25 uses this code to modulate the internally generated 22 kHz carrier. If EXTM=TEN=1: it accepts external 22 kHz logic signals which activate the 22 kHz tone output (refer to <i>Section 2.3</i>). Pull-up high if the tone output is activated only by the TEN I ² C bit.
23	DSQOUT	DiSEqC output	Open drain output of the tone detector to the main microcontroller for DiSEqC 2.0 data decoding. It is low when tone is detected to the DETIN input pin. Set to ground if not used.
Epad	Epad	Exposed pad	To be connected with power grounds and to the ground layer through vias to dissipate the heat.
1, 5, 10, 11, 12, 13, 14, 24	N.C.	Not internally connected	Not internally connected pins. These pins can be connected to GND to improve thermal performances.

 Table 2.
 Pin description (continued)





4 Maximum ratings

Symbol	Parameter	Value	Unit
V _{CC}	DC power supply input voltage pins	-0.3 to 20	V
V _{UP}	DC input voltage	-0.3 to 40	V
I _{OUT}	Output current	Internally limited	mA
V _{OUT}	DC output pin voltage	-0.3 to 40	V
VI	Logic input pins voltage (SDA, SCL, DSQIN, ADDR pins)	-0.3 to 7	V
Vo	Logic output pins voltage (FLT, DSQOUT)	-0.3 to 7	V
V _{BPSW}	BPSW pin voltage	-0.3 to 40	V
V _{DETIN}	Detector input signal amplitude	-0.6 to 2	V
۱ ₀	Logic output pins current (FLT, DSQOUT, BPSW)	10	mA
LX	LX input voltage	-0.3 to 30	V
V _{BYP}	Internal reference pin voltage	-0.3 to 4.6	V
ISEL	Current selection pin voltage	-0.3 to 3.5	V
T _{STG}	Storage temperature range	-50 to 150	°C
TJ	Operating junction temperature range	-25 to 125	°C
ESD	ESD rating with human body model (HBM) all pins, unless power output pins	2	kV
	ESD rating with human body model (HBM) for power output pins	4	

Table 4. Thermal data

Symbol	Parameter	Value	Unit
RthJC	Thermal resistance junction-case	2	°C/W
RthJA	Thermal resistance junction-ambient with device soldered on 2s2p 4- layer PCB provided with thermal vias below exposed pad.	40	°C/W

Note: Absolute maximum ratings are those values beyond which damage to the device may occur. These are stress ratings only and functional operation of the device at these conditions is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability. All voltage values are with respect to network ground terminal.



5 Typical application circuits

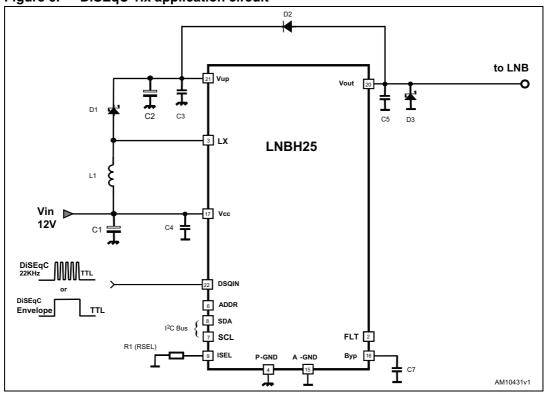


Figure 6. DiSEqC 1.x application circuit

Table 5. DiSEqC 1.X bill of material

Component	Notes
R1 (RSEL)	SMD resistor. Refer to Table 13 and ISEL pin description in Table 2
C1, C2	> 25 V electrolytic capacitor, 100 μ F is suitable.
C3	From 470 nF to 2.2 μ F ceramic capacitor. Higher values allow lower DC-DC noise.
C5	From 100 nF to 220 nF ceramic capacitor. Higher values allow lower DC-DC noise.
C4, C7	220 nF ceramic capacitors.
D1	STPS130A or similar schottky diode.
D3	BAT54, BAT43, 1N5818, or any low power schottky diode with I_F (AV) > 0.2 A, V_{RRM} > 25 V, V_F < 0.5 V. To be placed as close as possible to V_{OUT} pin.
D2	1N4001-07, S1A-S1M, or any similar general purpose rectifier.
L1	10 μ H inductor with I _{sat} > I _{peak} where I _{peak} is the boost converter peak current.



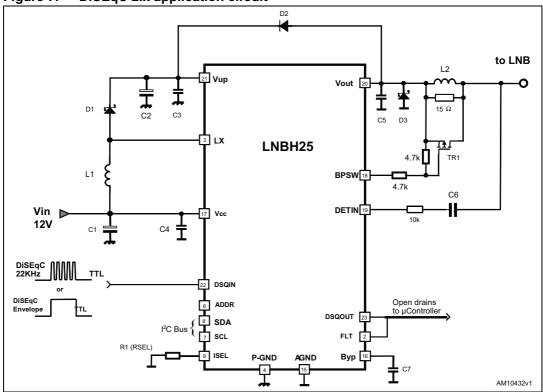


Figure 7. DiSEqC 2.x application circuit

 Table 6.
 DiSEqC 2.x bill of material

Component	Notes			
R1 (RSEL)) SMD resistors. Refer to <i>Table 13</i> and ISEL pin description in <i>Table 2</i>			
C1, C2	> 25 V electrolytic capacitor, 100 μ F is suitable.			
C3	From 470 nF to 2.2 μF ceramic capacitor. Higher values allow lower DC-DC noise.			
C5	From 100 nF to 220 nF ceramic capacitor. Higher values allow lower DC-DC noise.			
C4, C7	220 nF ceramic capacitors.			
C6	10 nF ceramic capacitors.			
D1	STPS130A or similar schottky diode.			
D3	BAT54, BAT43, 1N5818, or any low power schottky diode with I_F (AV) > 0.2 A, V_{RRM} > 25 V, V_F < 0.5 V. To be placed as close as possible to V_{OUT} pin.			
D2	1N4001-07, S1A-S1M, or any similar general purpose rectifier.			
L1	10 μ H inductor with I _{sat} > I _{peak} where I _{peak} is the boost converter peak current.			
L2	220 μH inductor.			
TR1	2STR2160 or 2STF2340 or any small power PNP with, IC > 250 mA, V _{CE} > 30 V can be used. Also any small power PMOS with ID > 250 mA, R _{DSON} < 0.5Ω , V _{DS} > 20 V, can be used.			

6 I²C bus interface

Data transmission from the main microprocessor to the LNBH25 and vice versa takes place through the 2-wire I²C bus interface, consisting of the 2-line SDA and SCL (pull-up resistors to positive supply voltage must be externally connected).

6.1 Data validity

As shown in *Figure 8*, the data on the SDA line must be stable during the high semi-period of the clock. The HIGH and LOW state of the data line can only change when the clock signal on the SCL line is LOW.

6.2 Start and stop condition

As shown in *Figure 9*, a start condition is a HIGH to LOW transition of the SDA line while SCL is HIGH. The stop condition is a LOW to HIGH transition of the SDA line while SCL is HIGH. A STOP condition must be sent before each START condition.

6.3 Byte format

Every byte transferred to the SDA line must contain 8 bits. Each byte must be followed by an acknowledge bit. The MSB is transferred first.

6.4 Acknowledge

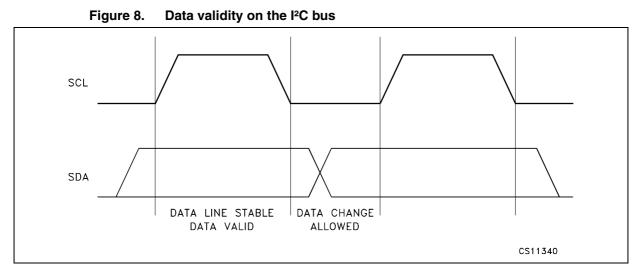
The master (microprocessor) puts a resistive HIGH level on the SDA line during the acknowledge clock pulse (see *Figure 10*). The peripheral (LNBH25) which acknowledges must pull down (LOW) the SDA line during the acknowledge clock pulse, so that the SDA line is stable LOW during this clock pulse. The peripheral which has been addressed has to generate acknowledge after the reception of each byte, otherwise the SDA line remains at the HIGH level during the ninth clock pulse time. In this case the master transmitter can generate the STOP information in order to abort the transfer. The LNBH25 won't generate acknowledge if the V_{CC} supply is below the undervoltage lockout threshold (4.7 V typ.).

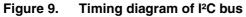
6.5 Transmission without acknowledge

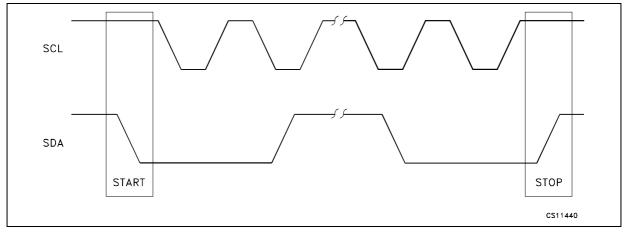
Avoiding to detect the acknowledges of the LNBH25, the microprocessor can use a simpler transmission: it simply waits one clock without checking the slave acknowledging, and sends the new data. This approach is of course less protected from misworking and decreases noise immunity.



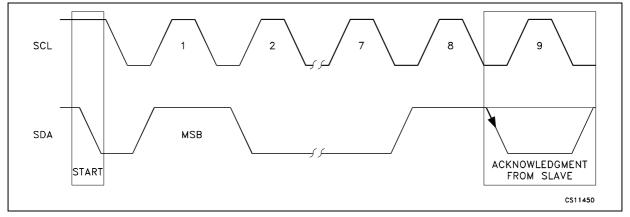
57











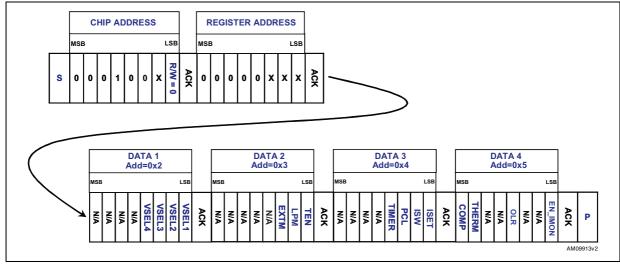
7 I²C interface protocol

7.1 Write mode transmission

The LNBH25 interface protocol comprises:

- a start condition (S)
- a chip address byte with the LSB bit R/W = 0
- a register address (internal address of the first register to be accessed)
- a sequence of data (byte to write in the addressed internal register + acknowledge)
- the following bytes, if any, to be written in successive internal registers
- a stop condition (P). The transfer lasts until a stop bit is encountered
- the LNBH25, as slave, acknowledges every byte transfer.

Figure 11. Example of writing procedure starting with first data address 0x2 ^(a)



ACK = Acknowledge

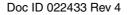
S = Start

P = Stop

R/W = 1/0, Read/Write bit

X = 0/1, set the values to select the CHIP ADDRESS (see Chip Address in *Table 16* for pin selection) and to select the REGISTER Address (see *Table 7*).

a. The writing procedure can start from any Register Address by simply setting the X values in the Register Address byte (after the Chip Address). It can be also stopped from the master by sending a stop condition after any acknowledge bit.

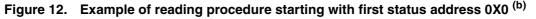


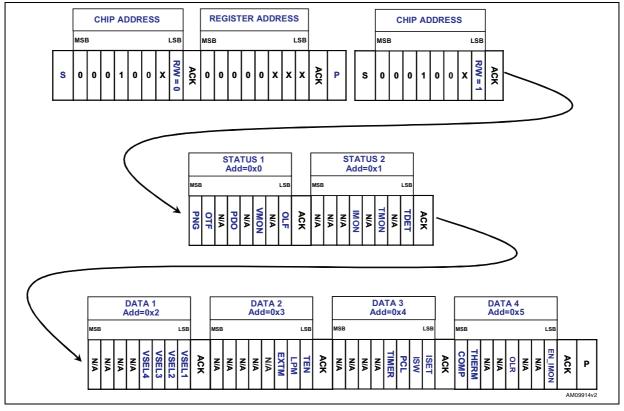


7.2 Read mode transmission

In Read mode the bytes sequence must be as follows:

- a start condition (S)
- a chip address byte with the LSB bit R/W=0
- the register address byte of the internal first register to be accessed
- a stop condition (P)
- a new master transmission with the chip address byte and the LSB bit R/W=1
- after the acknowledge the LNBH25 starts to send the addressed register content. As long as the master keeps the acknowledge LOW, the LNBH25 transmits the next address register byte content.
- the transmission is terminated when the master sets the acknowledge HIGH with a following stop bit.





ACK = Acknowledge

P = Stop

R/W = 1/0, Read/Write bit

X = 0/1, set the values to select the CHIP ADDRESS (see Chip Address in *Table 16* for pin selection) and to select the REGISTER Address (see *Table 7*).

b. The reading procedure can start from any register address (Status 1, 2 or Data1..4) by simply setting the X values in the register address byte (after the first Chip Address in the above figure). It can be also stopped from the master by sending a stop condition after any acknowledge bit.



7.3 Data registers

The DATA 1..4 registers can be addressed both in write and read mode. In read mode they return the last writing byte status received in the previous write transmission.

The following tables provide the Register Address values of Data 1..4 and a function description of each bit.

	DATA T (ficad/white register. fiegister address = 0x2)		
BIT	Name	Value	Description
Bit 0 (LSB)	VSEL1	0/1	
Bit 1	VSEL2	0/1	Output voltage selection bits. (Refer to <i>Table 14</i>)
Bit 2	VSEL3	0/1	
Bit 3	VSEL4	0/1	
Bit 4	N/A	0	Reserved. Keep to "0"
Bit 5	N/A	0	Reserved. Keep to "0"
Bit 6	N/A	0	Reserved. Keep to "0"
Bit 7 (MSB)	N/A	0	Reserved. Keep to "0"

Table 7. DATA 1 (Read/Write register. Register address = 0X2)

N/A = Reserved bit.

All bits reset to "0" at power-on.

Table 8.	DATA 2 (Read/Write register. Register address = 0X3)
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BIT	Name	Value	Description
Bit 0	TEN	1	22 kHz tone enabled. Tone output controlled by DSQIN pin
(LSB)		0	22 kHz tone output disabled
			Low power mode activated (used only with 22 kHz tone output disabled)
Bit 1	LPM	0	Low power mode deactivated (keep always LPM = 0 during 22 kHz tone transmission)
Bit 2		1	DSQIN input pin is set to receive external 22 kHz TTL signal source
Dil 2	Bit 2 EXTM		DSQIN input pin is set to receive external DiSEqC envelope TTL signal
Bit 3	N/A	0	Reserved. Keep to "0"
Bit 4	N/A	0	Reserved. Keep to "0"
Bit 5	N/A	0	Reserved. Keep to "0"
Bit 6	N/A	0	Reserved. Keep to "0"
Bit 7 (MSB)	N/A	0	Reserved. Keep to "0"

N/A = Reserved bit.

All bits reset to 0 at power-on.



BIT	Name	Value	Description
Bit 0	ISET	1	Current limit of LNB output (V _{OUT} pin) set to lower current range. Refer to <i>Section 2.6</i> in Application Information section.
(LSB)		0	Current Limit of LNB output (V _{OUT} pin) set to default range. Refer to <i>Section 2.6</i> in Application Information section.
Bit 1	ISW	1	DC-DC, inductor switching current limit set to 2.5 A typ.
DILI	1370	0	DC-DC, inductor switching current limit set to 4 A typ.
Bit 2	PCL	1	Pulsed (Dynamic) LNB output current limiting is deactivated
Dit 2	TOL	0	Pulsed (Dynamic) LNB output current limiting is activated
Bit 3	TIMER	1	Pulsed (Dynamic) LNB output current TON time set to 180 ms typ.
DILO		0	Pulsed (Dynamic) LNB output current TON time set to 90 ms typ.
Bit 4	N/A	0	Reserved. Keep to "0"
Bit 5	N/A	0	Reserved. Keep to "0"
Bit 6	N/A	0	Reserved. Keep to "0"
Bit 7 (MSB)	N/A	0	Reserved. Keep to "0"

 Table 9.
 DATA 3 (Read/Write register. Register address = 0X4)

N/A = Reserved bit.

All bits reset to 0 at power-on.

BIT	Name	Value	Description
Bit 0 EN IMON		1	IMON Diagnostic function is enabled. (V _{OUT} is set to 21 V typ.)
(LSB)		0	IMON Diagnostic function is disabled, keep always at "0" if IMON is not used
Bit 1	N/A	-	Reserved
Bit 2	N/A	-	Reserved
Bit 3		1	In case overload protection activation (OLF=1), all VSEL 14 bits are reset to "0" and LNB output (V_{OUT} pin) is disabled. The VSEL bits must be set again by the master after the overcurrent condition is removed (OLF=0).
		0	In case of overload protection activation (OLF=1) the LNB output (V_{OUT} pin) is automatically enabled as soon as the overload conditions is removed (OLF=0) with the previous VSEL bits setting.
Bit 4	N/A	-	Reserved
Bit 5	N/A	-	Reserved

Table 10.	DATA 4 (Read/Write register. Register address = 0X5) (continued)			DATA 4 (Read/V	
BIT	Name	Value	Description		
Bit 6	THERM	1	If Thermal protection is activated (OTF=1), all VSEL 14 bits are reset to "0" and LNB output (V_{OUT} pin) is disabled. The VSEL bits must be set again by the master after the overtemperature condition is removed (OTF=0).		
		0	In case of Thermal protection activation (OTF=1) the LNB output (V _{OUT} pin) is automatically enabled as soon as the overtemperature condition is removed (OTF=0) with the previous VSEL bits setting.		
Bit 7	COMP	1	DC-DC converter compensation set to use HIGH ESR capacitors (V_{UP} pin)		
(MSB)	COMP	0	DC-DC converter compensation set to use LOW ESR capacitors (VIIP pin)		

Table

N/A = Reserved bit.

All bits reset to 0 at power-on.

7.4 **Status registers**

The STATUS 1, 2 registers can be addressed only in read mode and provide the diagnostic functions described in the following tables.

DC-DC converter compensation set to use LOW ESR capacitors (V_{UP} pin)

BIT	Name	Value	Description	
Bit 0 (LSB) OLF		1	V_{OUT} pin overload protection has been triggered ($I_{OUT} > I_{MAX}$). Refer to <i>Table 9</i> for the overload operation settings (ISET, PCL, TIMER bits).	
(LOD)		0	No overload protection has been triggered to the V_{OUT} pin ($I_{OUT} < I_{MAX}$).	
Bit 1	N/A	-	Reserved	
Bit 2	VMON	1	Output voltage (V _{OUT} pin) lower than VMON specification thresholds. Refer to <i>Table 17</i> .	
		0	Output voltage (V _{OUT} pin) is within the VMON specifications.	
Bit 3	N/A	-	Reserved	
Bit 4	Bit 4 PDO		Overcurrent detected on output pull-down stage for a time longer than the deglitch period. This may happen due to an external voltage source present on the LNB output (V_{OUT} pin).	
		0	No overcurrent detected on output pull-down stage.	
Bit 5	N/A	-	Reserved	
Bit 6	075	1	Junction overtemperature is detected, $T_J > 150$ °C. See also THERM bit setting in <i>Table 10</i> .	
Bit 6 OTF		0	Junction overtemperature not detected, $T_J < 135$ °C. T_J is below thermal protection threshold.	
Bit 7	PNG	1	Input voltage (V _{CC} pin) lower than LPD minimum thresholds. Refer to <i>Table 13</i> .	
(MSB)	(MSB)		Input voltage (V _{CC} pin) higher than LPD thresholds. Refer to <i>Table 13</i> .	

STATUS 1 (Read register. Register address = 0X0) Table 11.

N/A = Reserved bit.

All bits reset to 0 at power-on.



BIT	Name	Value	Description
Bit 0	TDET	1	22 kHz tone presence is detected on the DETIN pin
(LSB)	IDEI	0	No 22 kHz tone is detected on the DETIN pin
Bit 1	N/A	-	Reserved
Bit 2	TMON	1	22 kHz tone present on the DETIN pin is out of TMON specification thresholds. That is: the tone frequency or the A_{TONE} (tone Amplitude) are out of the thresholds guaranteed in the TMON electrical characteristics table.
			22 kHz tone present on the DETIN pin is within TMON specification thresholds. Refer to <i>Table 19</i> .
Bit 3	N/A	-	Reserved
Bit 4	Bit 4 IMON		Output current (from V_{OUT} pin) is lower than IMON specification thresholds. Refer to <i>Table 18</i> .
DIL 4	INCIN	0	Output current (from V _{OUT} pin) is higher than IMON specifications. Refer to <i>Table 18</i> .
Bit 5	N/A	-	Reserved
Bit 6	N/A	-	Reserved
Bit 7 (MSB)	N/A	-	Reserved

Table 12. STATUS 2 (Read register. Register address = 0X1)

N/A = Reserved bit.

All bits reset to 0 at power-on.



8 Electrical characteristics

Refer to Section 5, T_J from 0 to 85 °C, all DATA 1..4 register bits set to 0 unless VSEL1 = 1, RSEL = 11.5 k Ω , DSQIN = LOW, V_{IN} = 12 V, I_{OUT} = 50 mA, unless otherwise stated. Typical values are referred to T_J = 25 °C. V_{OUT} = V_{OUT} pin voltage. See software description section for I²C access to the system register (Section 6 and Section 7).

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
V _{IN}	Supply voltage ⁽¹⁾		8	12	16	V	
		I _{OUT} = 0 mA		6		mA	
I _{IN}	Supply current	22 kHz Tone enabled (TEN=1), DSQIN = High, I _{OUT} = 0 mA		10		mA	
		VSEL1=VSEL2=VSEL3=VSEL4=0		1		mA	
V _{OUT}	Output voltage total accuracy	Valid at any V_{OUT} selected level	-3.5		+3.5	%	
V _{OUT}	Line regulation	V _{IN} = 8 to 16 V			40	mV	
V _{OUT}	Load regulation	I _{OUT} from 50 to 750 mA		100		mv	
		RSEL = 11.5 kΩ, ISET = 0	750		1100	mA	
I _{MAX}	Output current limiting thresholds	RSEL = 16.2 kΩ, ISET = 0	500		750		
		RSEL = 22 kΩ, ISET = 0	350		550		
		RSEL = 11.5 kΩ, ISET = 1		500		mA	
I _{MAX}	Output current limiting thresholds	RSEL = 16.2 kΩ, ISET = 1		350			
		RSEL = 22 kΩ, ISET = 1		250			
I _{SC}	Output short-circuit current	RSEL = 11.5 kΩ, ISET= 0		500		mA	
SS	Soft-start time	V _{OUT} from 0 to 13 V		4		ms	
SS	Soft-start time	V _{OUT} from 0 to 18 V		6		ms	
T13-18	Soft transition rise time	V _{OUT} from 13 to 18 V		1.5		ms	
T18-13	Soft transition fall time	V _{OUT} from 18 to 13 V		1.5		ms	
T _{OFF}	Dynamic overload protection OFF Time	PCL=0, Output Shorted		900			
т	Dynamic overload protection	PCL = TIMER = 0, Output Shorted		T _{OFF} /10		ms	
T _{ON}	ON Time	PCL = 0, TIMER = 1, Output Shorted		T _{OFF} /5			
A _{TONE}	Tone amplitude	DSQIN=High, EXTM=0, TEN=1 I _{OUT} from 0 to 750 mA C _{BUS} from 0 to 750 nF	0.55	0.675	0.8	V _{PP}	
F _{TONE}	Tone frequency		20	22	24	kHz	
D _{TONE}	Tone duty cycle	DSQIN=High, EXTM=0, TEN=1	43	50	57	%	
tr, tf	Tone rise or fall time ⁽²⁾		5	8	15	μs	
Eff _{DC/DC}	DC-DC converter efficiency	I _{OUT} = 500 mA		93		%	

 Table 13.
 Electrical characteristics



Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
F _{SW}	DC-DC converter switching frequency			440		kHz	
UVLO	Undervoltage lockout	UVLO Threshold Rising		4.8		V	
UVLO	thresholds	UVLO Threshold Falling		4.7		V	
V _{LP}	Low power diagnostic (LPD)	V _{LP} Threshold Rising		7.2		v	
۷LP	thresholds	V _{LP} Threshold Falling		6.7			
V _{IL}	DSQIN, pin logic low				0.8	V	
V _{IH}	DSQIN, pin logic high		2			V	
I _{IH}	DSQIN, pin input current	V _{IH} = 5 V		15		μA	
F _{DETIN}	Tone detector frequency capture range ⁽³⁾	0.4V _{PP} sine wave	19	22	25	kHz	
V _{DETIN}	Tone detector input amplitude ⁽³⁾	Sine wave signal, 22 kHz	0.3		1.5	V _{PP}	
Z _{DETIN}	Tone detector input impedance			150		kΩ	
V _{OL_BPS} W	BPSW pin low voltage	I _{OL_BPSW} = 5 mA, DSQIN = high, EXTM=0, TEN=1		0.7		v	
V _{OL}	DSQOUT, FLT pins logic LOW	DETIN Tone present, I _{OL} = 2 mA		0.3	0.5	v	
I _{OZ}	DSQOUT, FLT pins leakage current	DETIN Tone absent, V _{OH} = 6 V			10	μA	
I _{OBK}	Output backward current	All VSELx=0, V _{OBK} = 30 V		-3	-6	mA	
I _{SINK}	Output low-side sink current	V_{OUT} forced at V_{OUT_NOM} + 0.1 V		70		mA	
I _{SINK_} TIME-OUT	Low-side sink current time- out	V _{OUT} forced at V _{OUT_NOM} + 0.1 V PDO I ² C bit is set to 1 after this time is elapsed		10		ms	
I _{REV}	Max. reverse current	V _{OUT} forced at V _{OUT_NOM} + 0.1 V after PDO bit is set to 1 (I _{SINK_TIME-OUT} elapsed)		2		mA	
T _{SHDN}	Thermal shut-down threshold			150		°C	
ΔT_{SHDN}	Thermal shut-down hysteresis			15		°C	

Table 13. Electrica	I characteristics	(continued)
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1. In applications where $(V_{CC} - V_{OUT}) > 1.3$ V the increased power dissipation inside the integrated LDO must be taken into account in the application thermal management design.

2. Guaranteed by design.

Frequency range in which the DETIN function is guaranteed. The V_{PP} level is intended on the LNB bus (before the C6 capacitor. See typical application circuit for DiSEqC 2.x). I_{OUT} from 0 to 750 mA, C_{BUS} from 0 to 750 nF.

